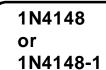
Silicon Switching Diode



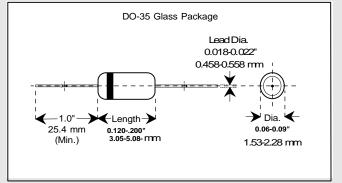
DO-35 Glass Package

Applications

Used in general purpose applications, where a controlled forward characteristic and fast switching speed are important.

Features

- Six sigma quality
- Metallurgically bonded
- BKC's Sigma Bond[™] plating for problem free solderability
- LL-34/35 MELF SMD available
- Hermetic Glass Body
- Available up to JANTXV-1 levels



"S" level screening available to Source Control Drawings-

			0		
Maximum Ratings			Symbo	I Value	Unit
Peak Inverse Voltage			PIV	100 (Min).	Volts
Average Rectified Current			lavg	200	mAmps
Continuous Forward Current			I _{Fdc}	300	mAmps
Peak Surge Current (t _{peak} = 1 sec.)			l _{peak}	1.0	Amp
BKC Power Dissipation $T_L=50 \text{ °C}$, L = 3/8" from body			P _{tot}	500	mWatts
Operating Temperature Range			T _{Op}	-65 to +200	° C
Storage Temperature Range			T _{st}	-65 to +200	° C
Electrical Characteristics @ 25 °C*	Symbol	Mi	nimum	Maximum	Unit
Forward Voltage Drop @ I _F = 10 mA	V _F	*	**	1.00	Volts
Breakdown Voltage @ I _R =5 µA	PIV	-	75		Volts
Breakdown Voltage @ I _R = 100µA	PIV	1	00		Volts
Reverse Leakage Current @ V _R = 75 V	I _R			5 (100 @ 150 °C)	μA
Capacitance @ $V_{R} = 0 V$, f = 1mHz	C _T			4.0	pF
Reverse Recovery time (note 1)	t _{rr}			4.0	nSecs

Note 1: Per Method 4031-A with I_F = 10 mA,Vr = 6 V, R_I = 100 Ohms. * UNLESS OTHERWISE SPECIFIED

